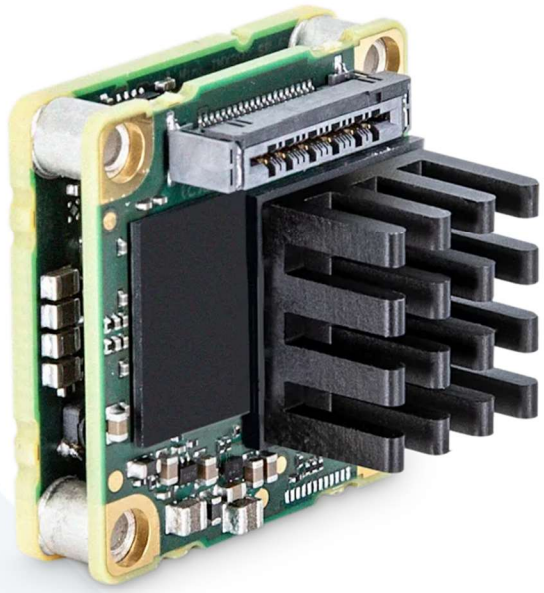
Heat sink for dart





Heat sink for the dart M provides heat dissipation from the camera module during product evaluation.

Well-suited for the first assessment of the dart M in customer applications.

Easy attachment directly to the FPGA on the back of the camera module

Includes pre-installed glue pad

Small and lightweight

General Information

Order Number	2200002313
Type	Cooling
Size (L x W x H)	14 mm x 14 mm x 10 mm
Thermal Resistance	26.5 K/V
Manufacturer	RS PRO